
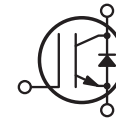


Thunderbolt IGBT®

The Thunderbolt IGBT® is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Thunderbolt IGBT® offers superior ruggedness and ultrafast switching speed.

Features

- Low Forward Voltage Drop
- Low Tail Current
- Integrated Gate Resistor
- Low EMI, High Reliability
- RoHS Compliant 
- RBSOA and SCSOA Rated
- High Frequency Switching to 50KHz
- Ultra Low Leakage Current



Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is made with two parallel IGBT die. It is intended for switch-mode operation. It is not suitable for linear mode operation.

Maximum Ratings

 All Ratings: $T_C = 25^\circ C$ unless otherwise specified.

| Symbol | Parameter | Ratings | Unit |
|----------------|---|--------------|------------|
| V_{CES} | Collector-Emitter Voltage | 1200 | Volts |
| V_{GE} | Gate-Emitter Voltage | ± 20 | |
| I_{C1} | Continuous Collector Current @ $T_C = 25^\circ C$ | 123 | Amps |
| I_{C2} | Continuous Collector Current @ $T_C = 100^\circ C$ | 67 | |
| I_{CM} | Pulsed Collector Current ^① | 200 | |
| SSOA | Switching Safe Operating Area @ $T_J = 150^\circ C$ | 200A @ 1200V | |
| P_D | Total Power Dissipation | 570 | Watts |
| T_J, T_{STG} | Operating and Storage Junction Temperature Range | -55 to 150 | $^\circ C$ |
| T_L | Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec. | 300 | |

Static Electrical Characteristics

| Symbol | Characteristic / Test Conditions | Min | Typ | Max | Unit |
|---------------|---|------|-----|-----|----------|
| $V_{(BR)CES}$ | Collector-Emitter Breakdown Voltage ($V_{GE} = 0V, I_C = 5mA$) | 1200 | - | - | Volts |
| $V_{GE(TH)}$ | Gate Threshold Voltage ($V_{CE} = V_{GE}, I_C = 4mA, T_J = 25^\circ C$) | 4.5 | 5.5 | 6.5 | |
| $V_{CE(ON)}$ | Collector Emitter On Voltage ($V_{GE} = 15V, I_C = 100A, T_J = 25^\circ C$) | 2.7 | 3.2 | 3.7 | |
| | Collector Emitter On Voltage ($V_{GE} = 15V, I_C = 100A, T_J = 125^\circ C$) | - | 4.0 | - | |
| I_{CES} | Collector Cut-off Current ($V_{CE} = 1200V, V_{GE} = 0V, T_J = 25^\circ C$) ^② | - | - | 200 | μA |
| | Collector Cut-off Current ($V_{CE} = 1200V, V_{GE} = 0V, T_J = 125^\circ C$) ^② | - | - | TBD | |
| I_{GES} | Gate-Emitter Leakage Current ($V_{GE} = \pm 20V$) | - | - | 600 | nA |
| $R_{G(int)}$ | Integrated Gate Resistor | - | 5 | - | Ω |

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

Dynamic Characteristic

APT100GT120JRDQ4

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|--------------|--|--|-------|-------|-----|---------|
| C_{ies} | Input Capacitance | $V_{GE} = 0V, V_{CE} = 25V$ $f = 1MHz$ | - | 6700 | - | pF |
| C_{oes} | Output Capacitance | | - | 655 | - | |
| C_{res} | Reverse Transfer Capacitance | | - | 440 | - | |
| V_{GEP} | Gate-to-Emitter Plateau Voltage | Gate Charge $V_{GE} = 15V$ $V_{CE} = 600V$ $I_C = 100A$ | - | 10.0 | - | V |
| Q_g | Total Gate Charge | | - | 685 | - | nC |
| Q_{ge} | Gate-Emitter Charge | | - | 75 | - | |
| Q_{gc} | Gate-Collector Charge | | - | 400 | - | |
| SSOA | Switching Safe Operating Area | $T_J = 150^{\circ}C, R_G = 1.0\Omega^{(2)}, V_{GE} = 15V,$ $L = 100\mu H, V_{CE} = 1200V$ | 150 | | | A |
| $t_{d(on)}$ | Turn-On Delay Time | Inductive Switching ($25^{\circ}C$) $V_{CC} = 800V$ $V_{GE} = 15V$ $I_C = 100A$ $R_G = 4.7\Omega$ $T_J = +25^{\circ}C$ | - | 50 | - | ns |
| t_r | Current Rise Time | | - | 100 | - | |
| $t_{d(off)}$ | Turn-Off Delay Time | | - | 630 | - | |
| t_f | Current Fall Time | | - | 36 | - | μJ |
| E_{on1} | Turn-On Switching Energy ⁽⁴⁾ | | - | TBD | - | |
| E_{on2} | Turn-On Switching Energy ⁽⁵⁾ | | - | 17600 | - | |
| E_{off} | Turn-Off Switching Energy ⁽⁶⁾ | - | 7240 | - | | |
| $t_{d(on)}$ | Turn-On Delay Time | Inductive Switching ($125^{\circ}C$) $V_{CC} = 800V$ $V_{GE} = 15V$ $I_C = 100A$ $R_G = 4.7\Omega$ $T_J = 125^{\circ}C$ | - | 50 | - | ns |
| t_r | Current Rise Time | | - | 100 | - | |
| $t_{d(off)}$ | Turn-Off Delay Time | | - | 710 | - | |
| t_f | Current Fall Time | | - | 37 | - | μJ |
| E_{on1} | Turn-On Switching Energy ⁽⁴⁾ | | - | TBD | - | |
| E_{on2} | Turn-On Switching Energy ⁽⁵⁾ | | - | 22380 | - | |
| E_{off} | Turn-Off Switching Energy ⁽⁶⁾ | - | 10950 | - | | |

Thermal and Mechanical Characteristics

| Symbol | Characteristic / Test Conditions | Min | Typ | Max | Unit |
|-----------------|--|------|------|------|---------------|
| $R_{\theta JC}$ | Junction to Case (IGBT) | - | - | 0.22 | $^{\circ}C/W$ |
| $R_{\theta JC}$ | Junction to Case (DIODE) | - | - | 0.56 | |
| W_T | Package Weight | - | 29.2 | - | g |
| $V_{isolation}$ | RMS Voltage (50-60Hz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.) | 2500 | - | - | Volts |

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② For Combi devices, I_{ces} includes both IGBT and FRED leakages.
- ③ See MIL-STD-750 Method 3471.
- ④ E_{on1} is the clamped inductive turn-on energy of the IGBT only, without the effect of a commutating diode reverse recovery current adding to z a the IGBT turn-on loss. Tested in inductive switching test circuit shown in figure 21, but with a Silicon Carbide diode.
- ⑤ E_{on2} is the clamped inductive turn-on energy that includes a commutating diode reverse recovery current in the IGBT turn-on switching loss. (See Figures 21, 22.)
- ⑥ E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1. (See Figures 21, 23.)
- ⑦ R_G is external gate resistance not including gate driver impedance.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

Typical Performance Curves

APT100GT120JRDQ4

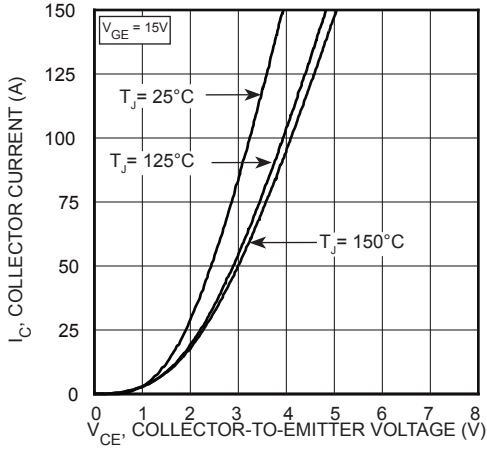


FIGURE 1, Output Characteristics ($T_J = 25^\circ\text{C}$)

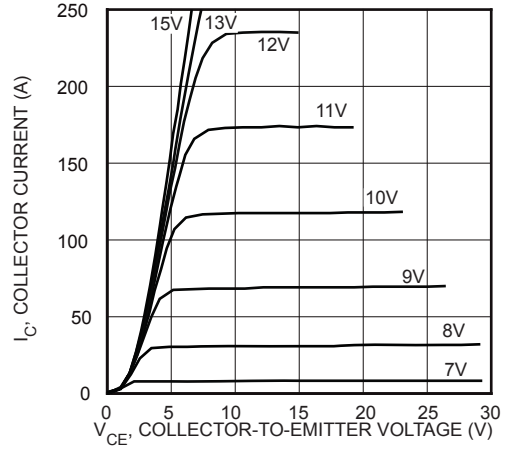


FIGURE 2, Output Characteristics ($T_J = 25^\circ\text{C}$)

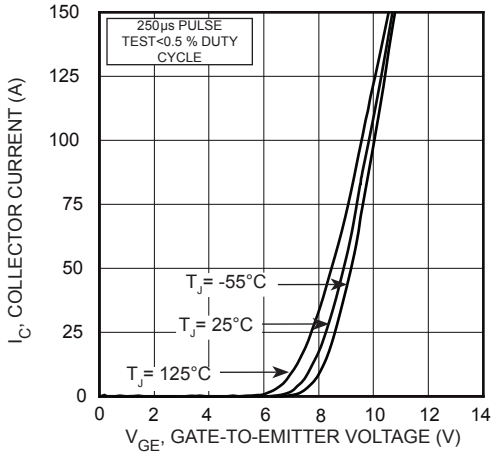


FIGURE 3, Transfer Characteristics

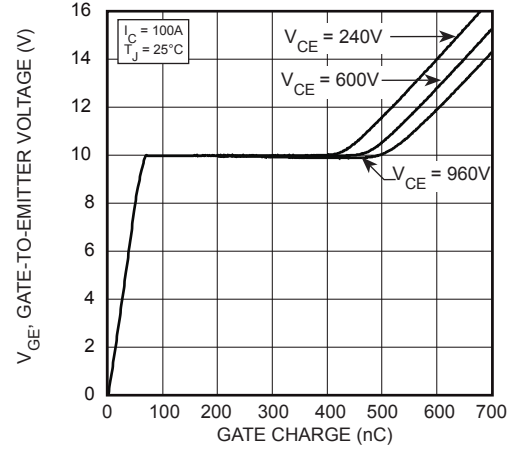


FIGURE 4, Gate charge

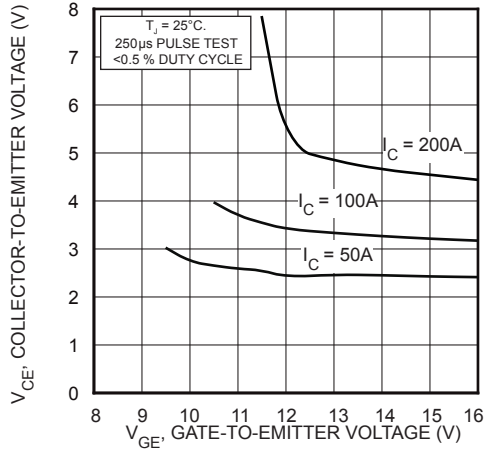


FIGURE 5, On State Voltage vs Gate-to-Emitter Voltage

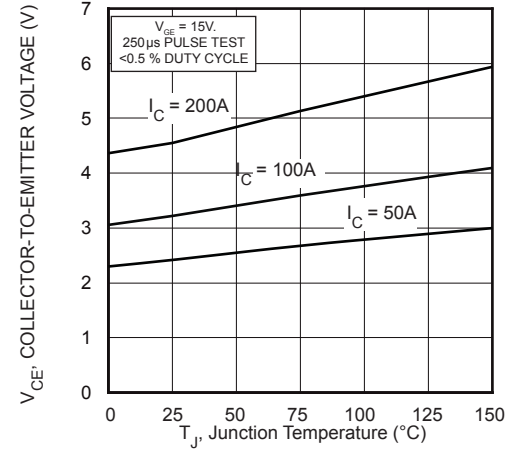


FIGURE 6, On State Voltage vs Junction Temperature

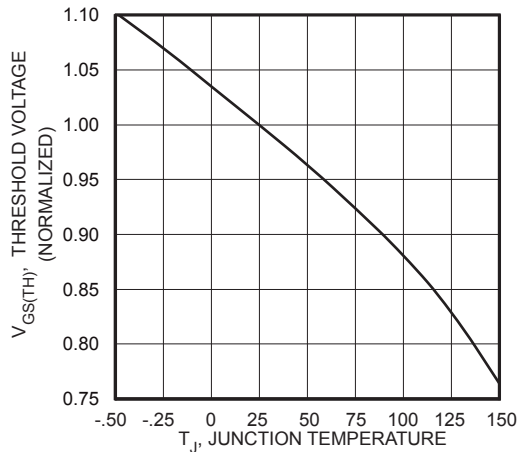


FIGURE 7, Threshold Voltage vs Junction Temperature

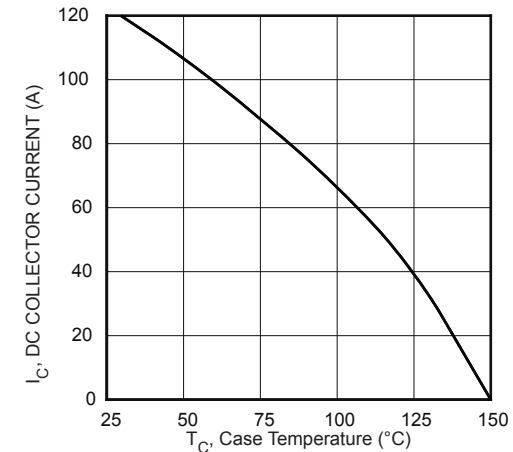


FIGURE 8, DC Collector Current vs Case Temperature

Typical Performance Curves

APT100GT120JRDQ4

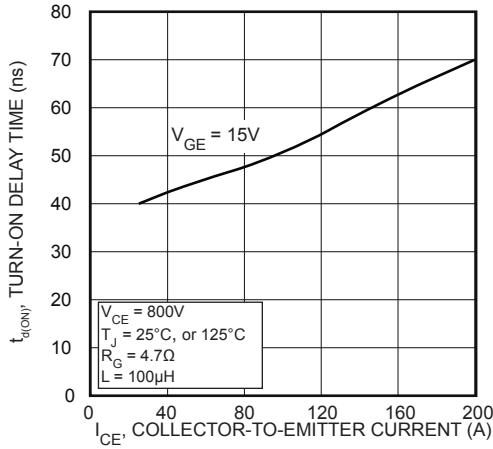


FIGURE 9, Turn-On Delay Time vs Collector Current

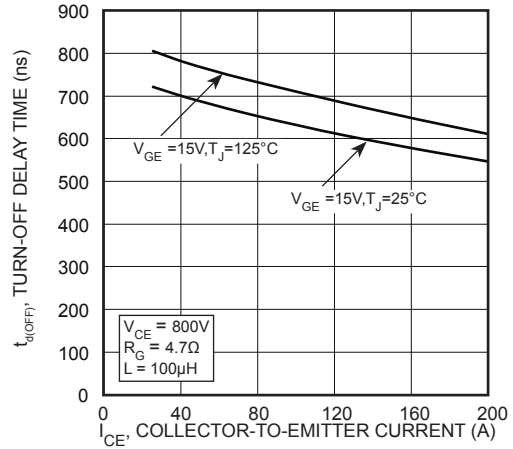


FIGURE 10, Turn-Off Delay Time vs Collector Current

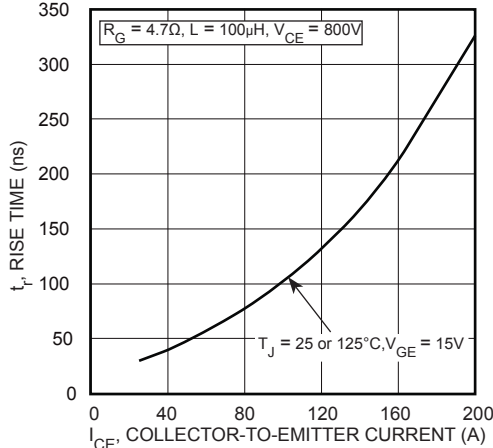


FIGURE 11, Current Rise Time vs Collector Current

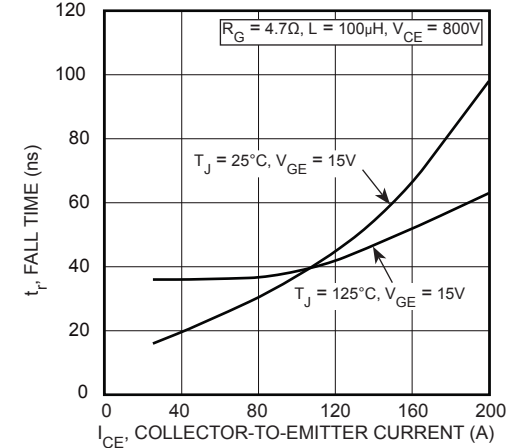


FIGURE 12, Current Fall Time vs Collector Current

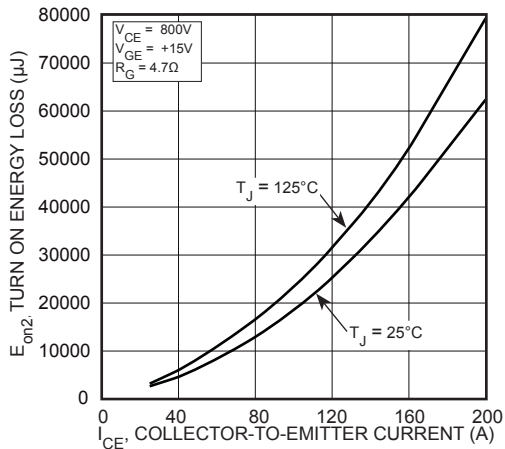


FIGURE 13, Turn-On Energy Loss vs Collector Current

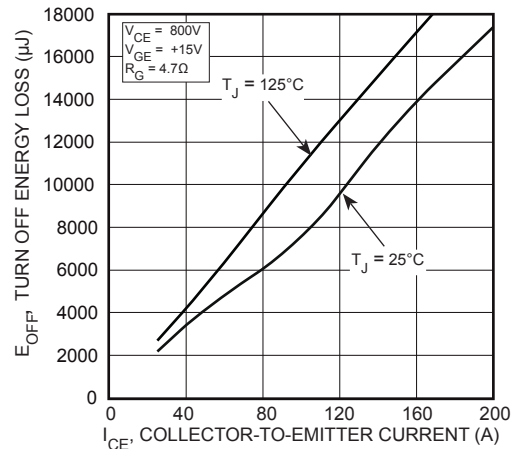


FIGURE 14, Turn-Off Energy Loss vs Collector Current

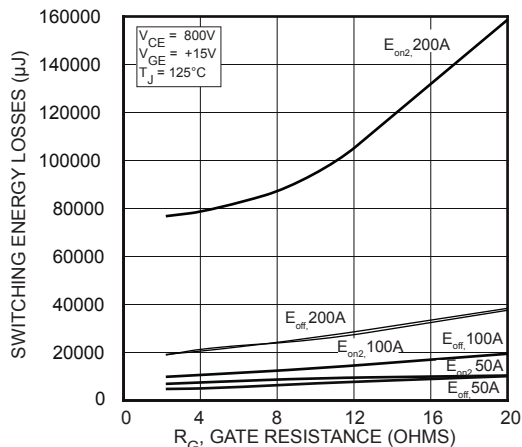


FIGURE 15, Switching Energy Losses vs Gate Resistance

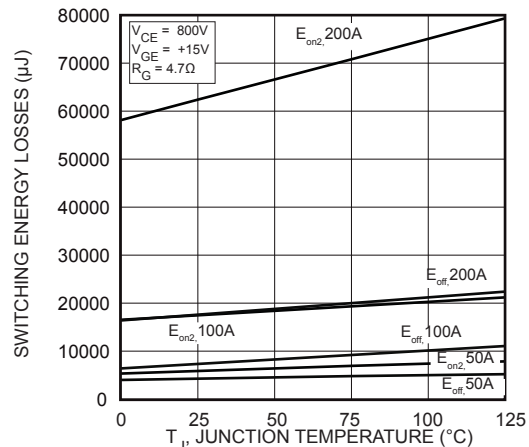


FIGURE 16, Switching Energy Losses vs Junction Temperature

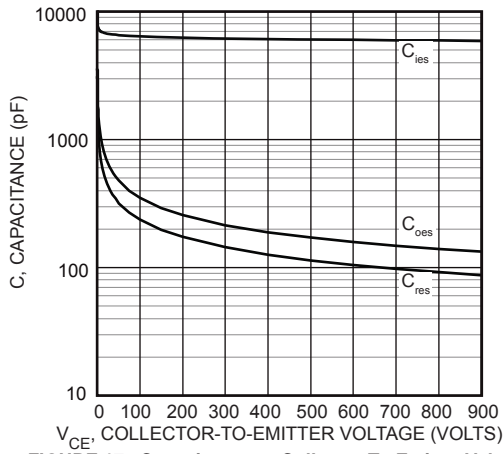


FIGURE 17, Capacitance vs Collector-To-Emitter Voltage

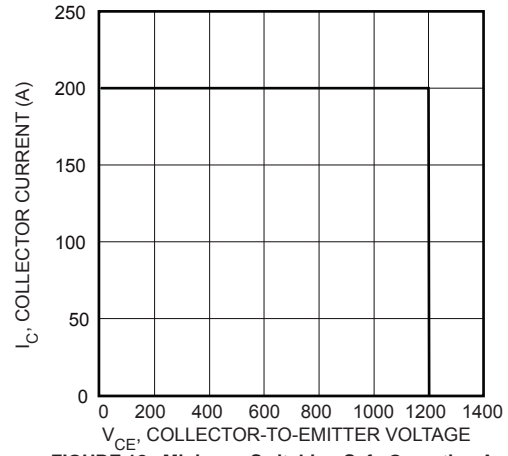


FIGURE 18, Minimum Switching Safe Operating Area

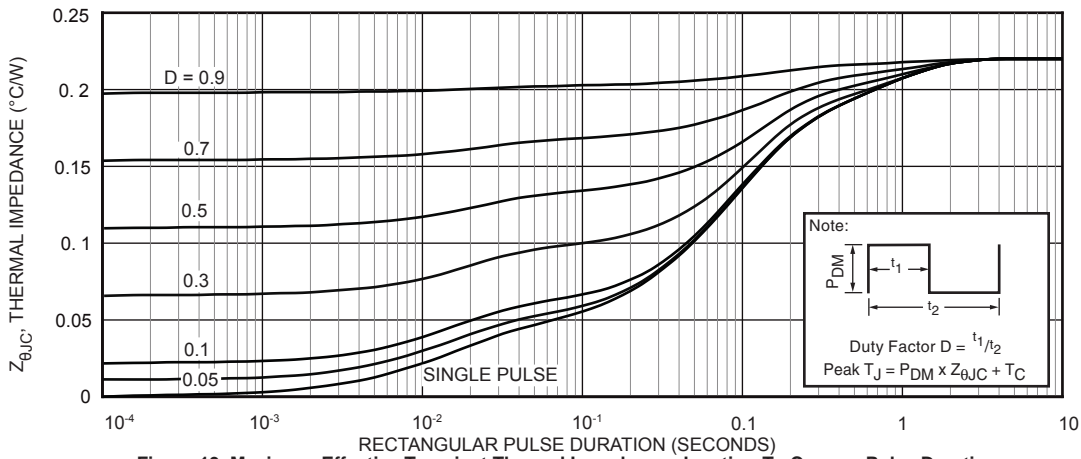


Figure 19, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

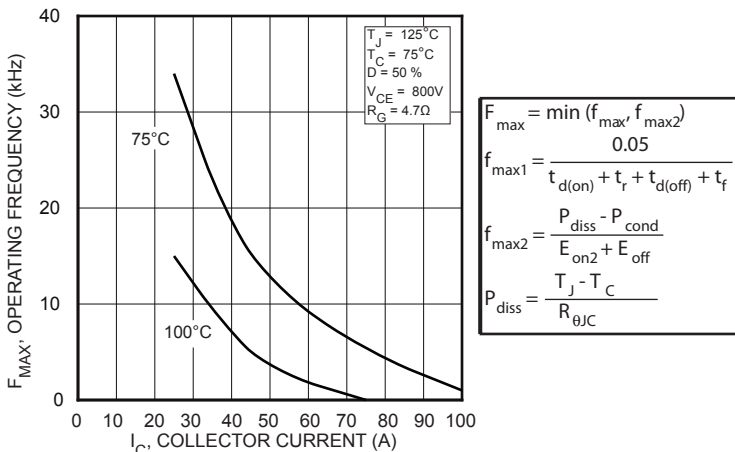


Figure 20, Operating Frequency vs Collector Current

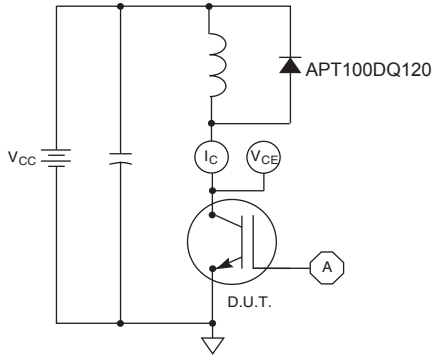


Figure 21, Inductive Switching Test Circuit

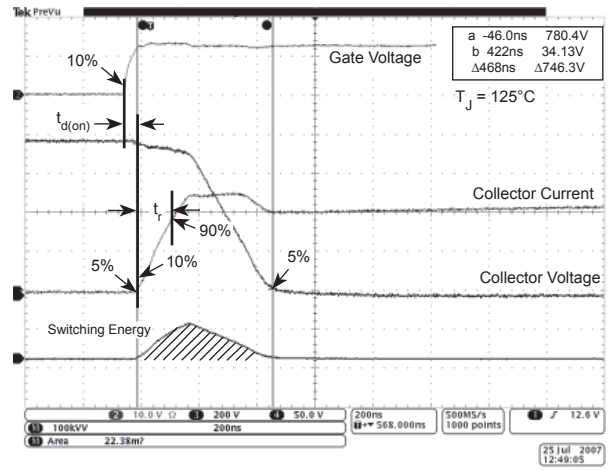


Figure 22, Turn-on Switching Waveforms and Definitions

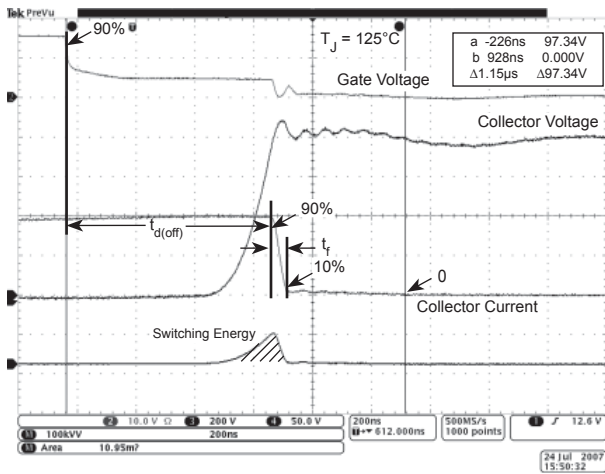


Figure 23, Turn-off Switching Waveforms and Definitions

ULTRAFAST SOFT RECOVERY ANTI-PARALLEL DIODE

MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

| Symbol | Characteristic / Test Conditions | APT100GT120JRDQ4 | Unit |
|--------------|--|------------------|------|
| $I_{F(AV)}$ | Maximum Average Forward Current ($T_C = 88^\circ\text{C}$, Duty Cycle = 0.5) | 60 | Amps |
| $I_{F(RMS)}$ | RMS Forward Current (Square wave, 50% duty) | 73 | |
| I_{FSM} | Non-Repetitive Forward Surge Current ($T_J = 45^\circ\text{C}$, 8.3 ms) | 540 | |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | Min | Type | Max | Unit |
|--------|----------------------------------|-----|---|------|-------|
| V_F | Forward Voltage | | $I_F = 75\text{A}$ | 2.8 | Volts |
| | | | $I_F = 150\text{A}$ | 3.48 | |
| | | | $I_F = 75\text{A}, T_J = 125^\circ\text{C}$ | 2.17 | |

DYNAMIC CHARACTERISTICS

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|-----------|----------------------------------|---|-----|------|-----|------|
| t_{rr} | Reverse Recovery Time | $I_F = 1\text{A}, di_F/dt = -100\text{A}/\mu\text{s}, V_R = 30\text{V}, T_J = 25^\circ\text{C}$ | - | 60 | - | ns |
| t_{rr} | Reverse Recovery Time | $I_F = 60\text{A}, di_F/dt = -200\text{A}/\mu\text{s}, V_R = 800\text{V}, T_C = 25^\circ\text{C}$ | - | 265 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 560 | - | nC |
| I_{RRM} | Maximum Reverse Recovery Current | | - | 5 | - | Amps |
| t_{rr} | Reverse Recovery Time | $I_F = 60\text{A}, di_F/dt = -200\text{A}/\mu\text{s}, V_R = 800\text{V}, T_C = 125^\circ\text{C}$ | - | 350 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 2890 | - | nC |
| I_{RRM} | Maximum Reverse Recovery Current | | - | 13 | - | Amps |
| t_{rr} | Reverse Recovery Time | $I_F = 60\text{A}, di_F/dt = -1000\text{A}/\mu\text{s}, V_R = 800\text{V}, T_C = 125^\circ\text{C}$ | - | 150 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 4720 | - | nC |
| I_{RRM} | Maximum Reverse Recovery Current | | - | 40 | - | Amps |

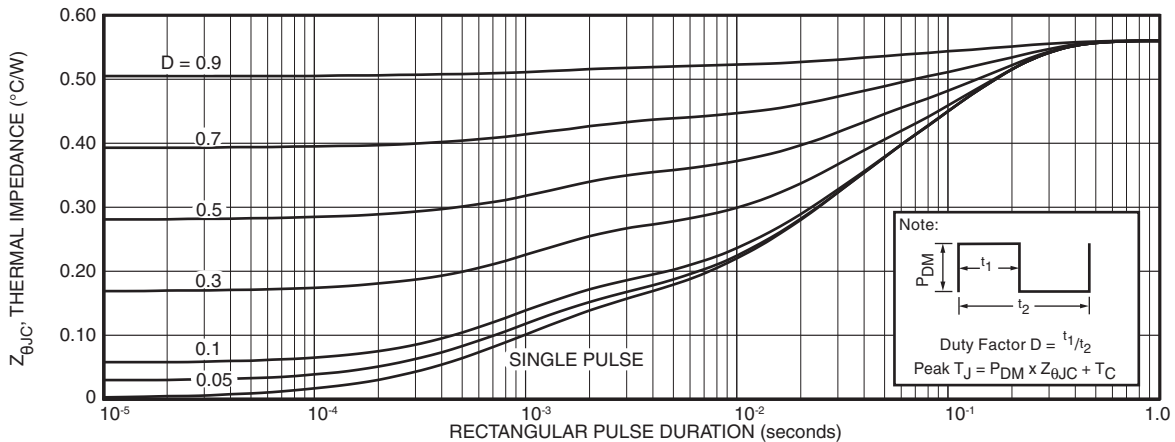


FIGURE 24. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION

Typical Performance Curves

APT100GT120JRDQ4

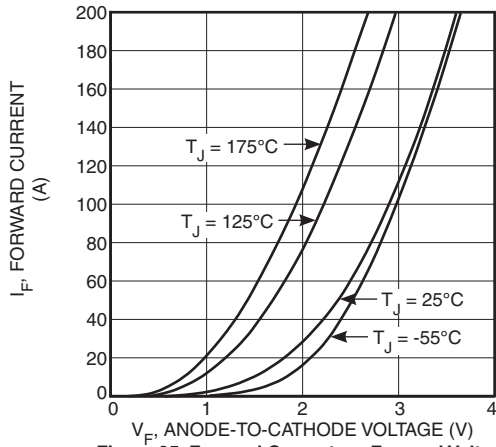


Figure 25. Forward Current vs. Forward Voltage

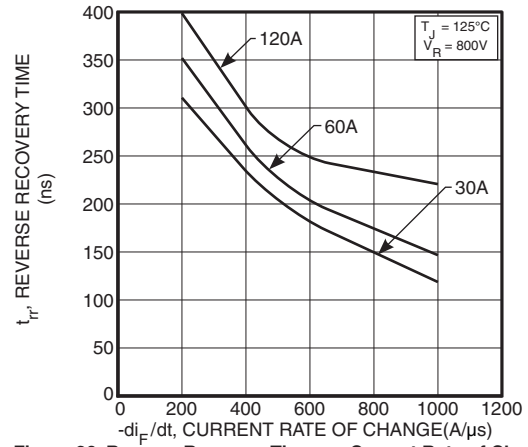


Figure 26. Reverse Recovery Time vs. Current Rate of Change

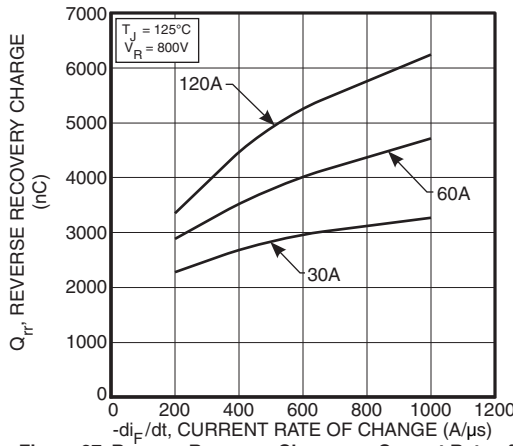


Figure 27. Reverse Recovery Charge vs. Current Rate of Change

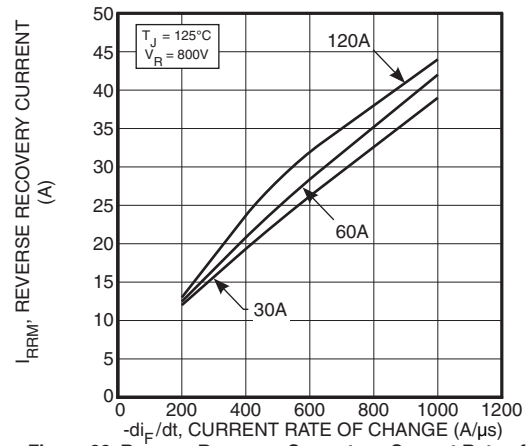


Figure 28. Reverse Recovery Current vs. Current Rate of Change

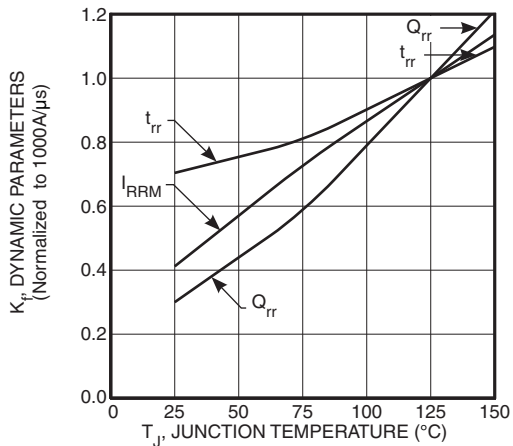


Figure 29. Dynamic Parameters vs. Junction Temperature

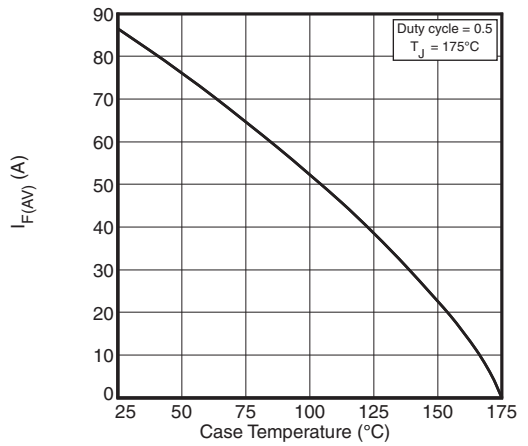


Figure 30. Maximum Average Forward Current vs. Case Temperature

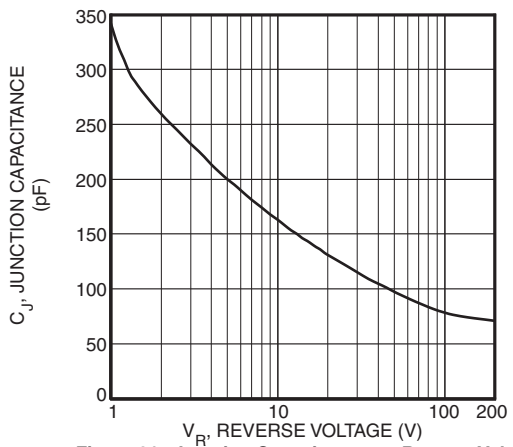


Figure 31. Junction Capacitance vs. Reverse Voltage

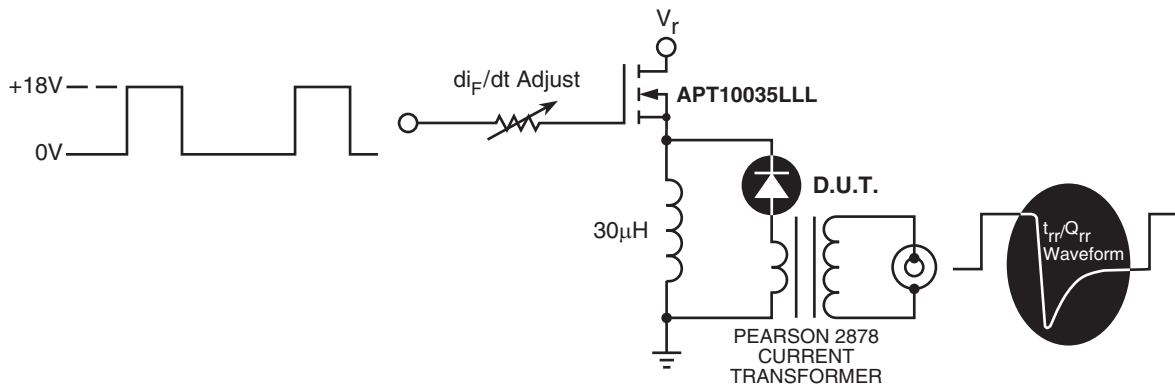


Figure 32, Diode Test Circuit

- 1 I_F - Forward Conduction Current
- 2 di_F/dt - Rate of Diode Current Change Through Zero Crossing.
- 3 I_{RRM} - Maximum Reverse Recovery Current.
- 4 t_{rr} - Reverse Recovery Time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I_{RRM} and $0.25 \cdot I_{RRM}$ passes through zero.
- 5 Q_{rr} - Area Under the Curve Defined by I_{RRM} and t_{rr} .

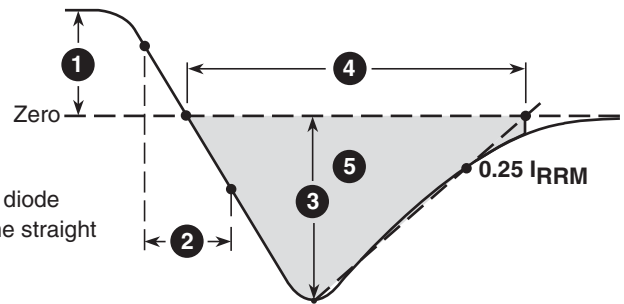
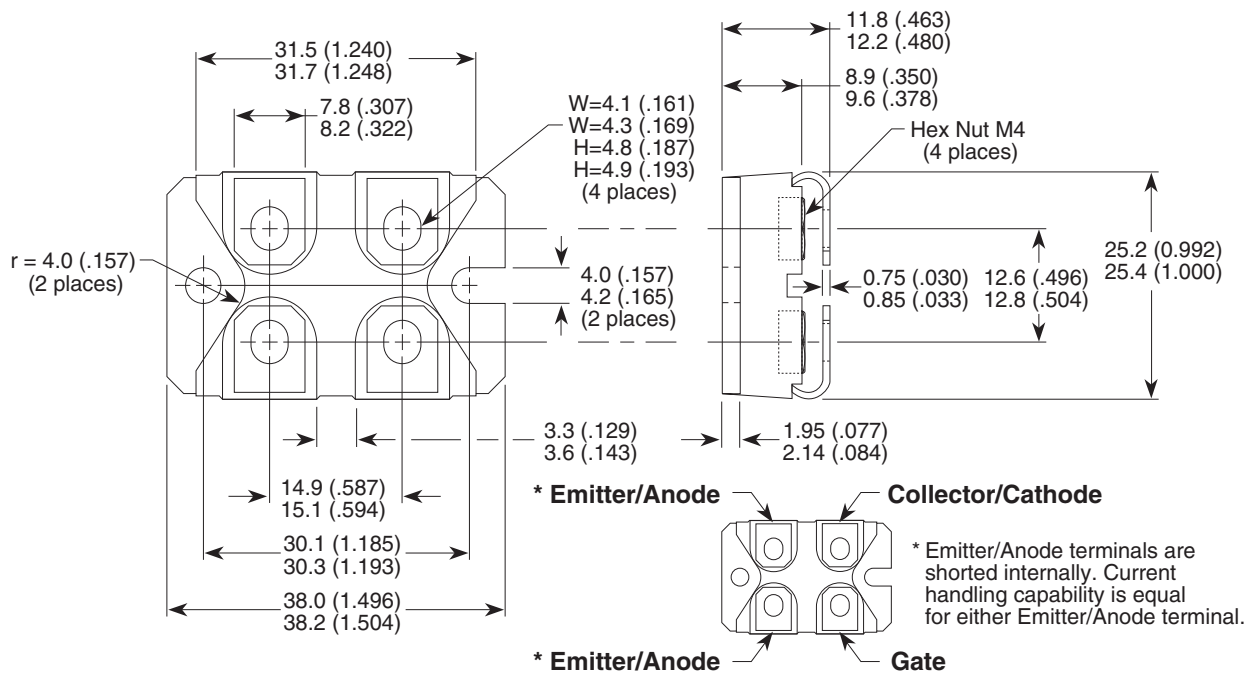


Figure 32, Diode Reverse Recovery Waveform and Definitions

SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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